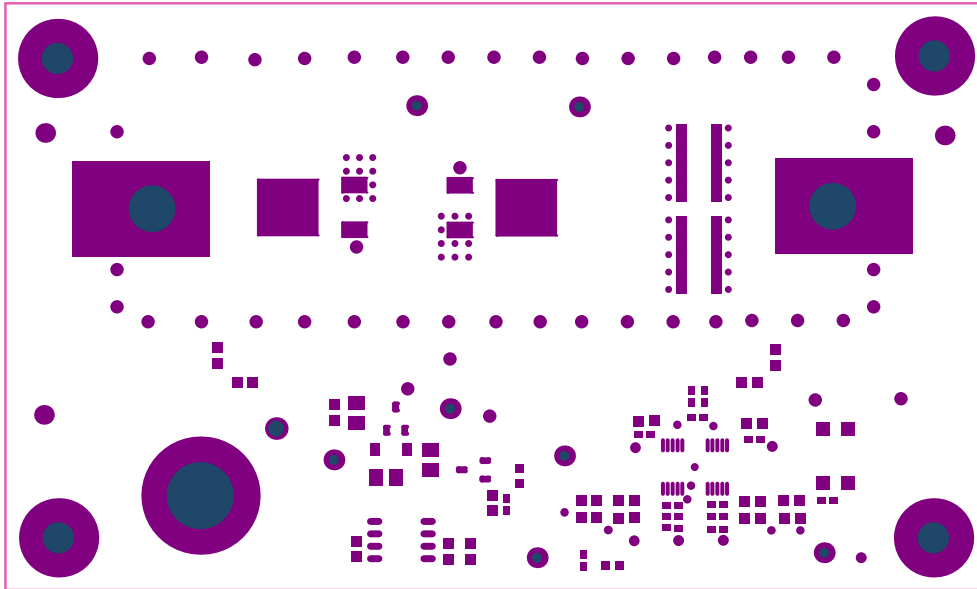
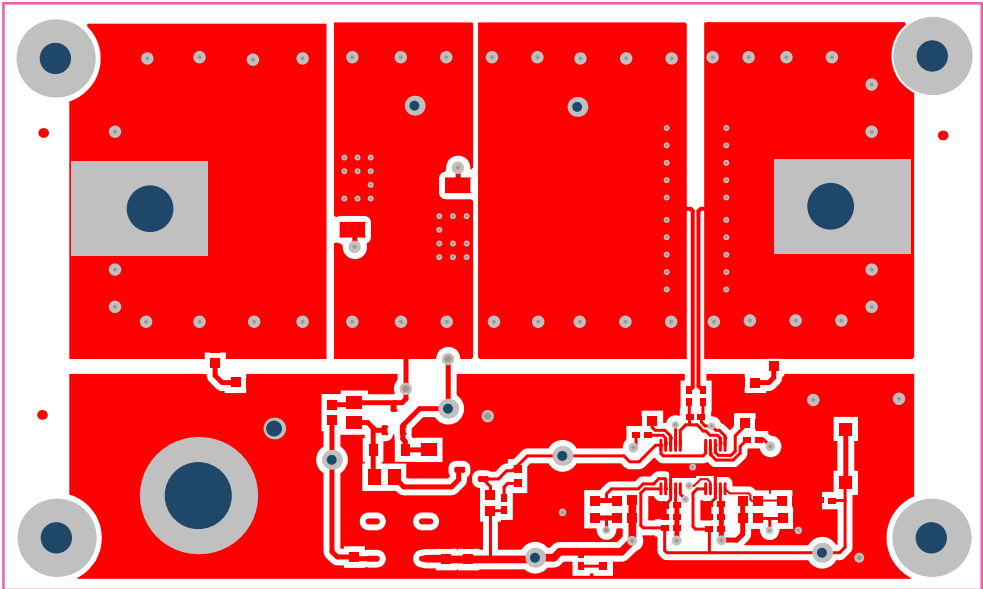


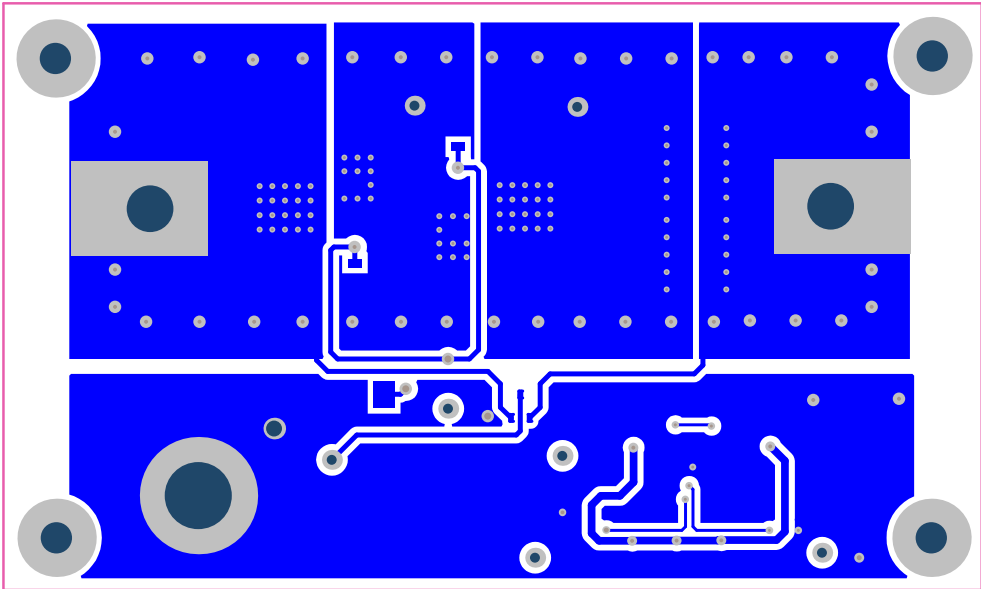
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00795	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00795		
PLOT NAME = Top Overlay	GENERATED : 2/23/2016	2:37:42 PM	TEXAS INSTRUMENTS



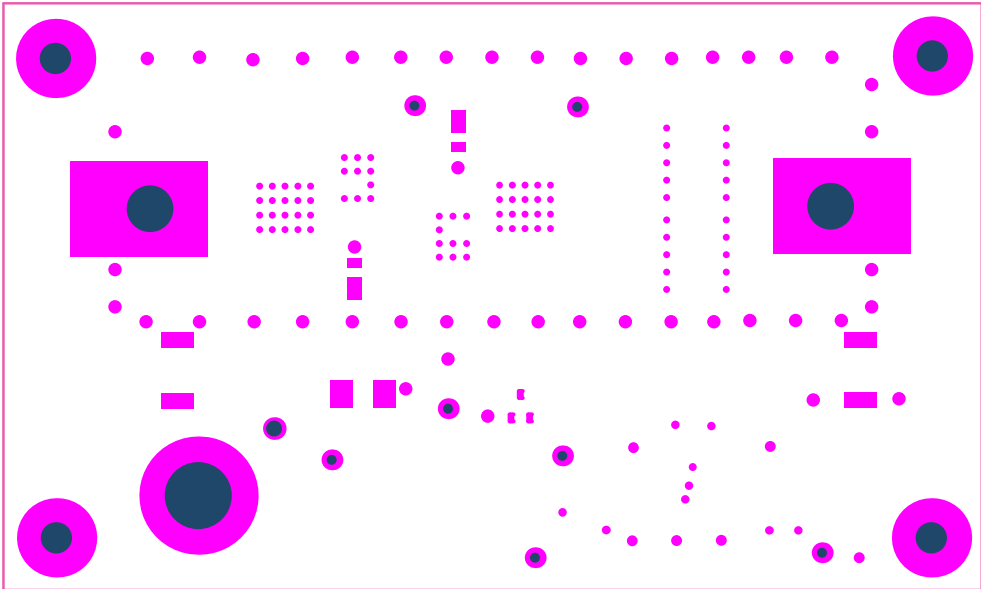
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00795	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00795		
PLOT NAME = Top Solder Mask	GENERATED : 2/23/2016 2:37:43 PM	TEXAS INSTRUMENTS	



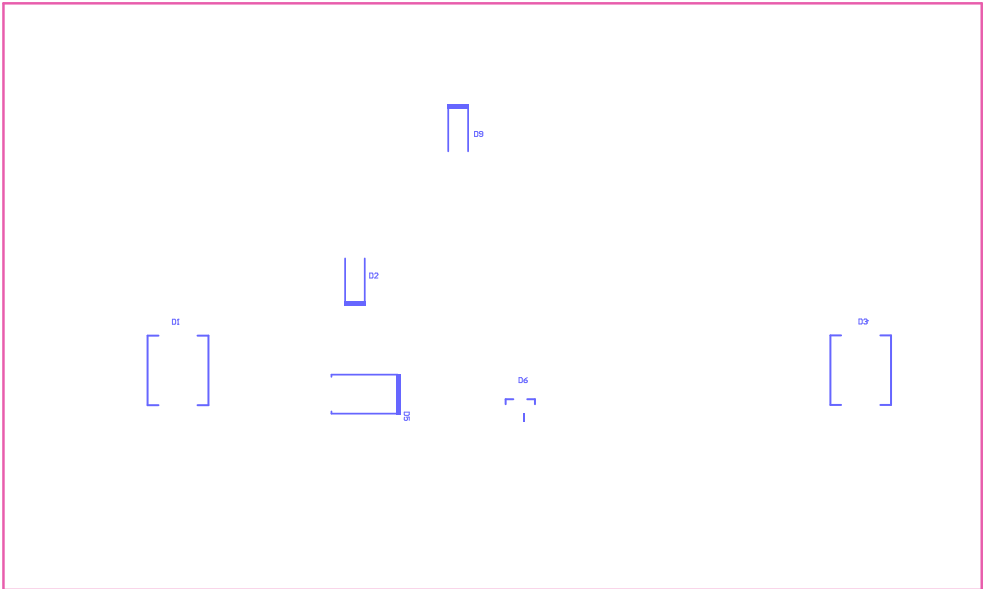
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00795	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00795		
PLOT NAME = Top Layer	GENERATED : 2/23/2016 2:37:44 PM	TEXAS INSTRUMENTS	



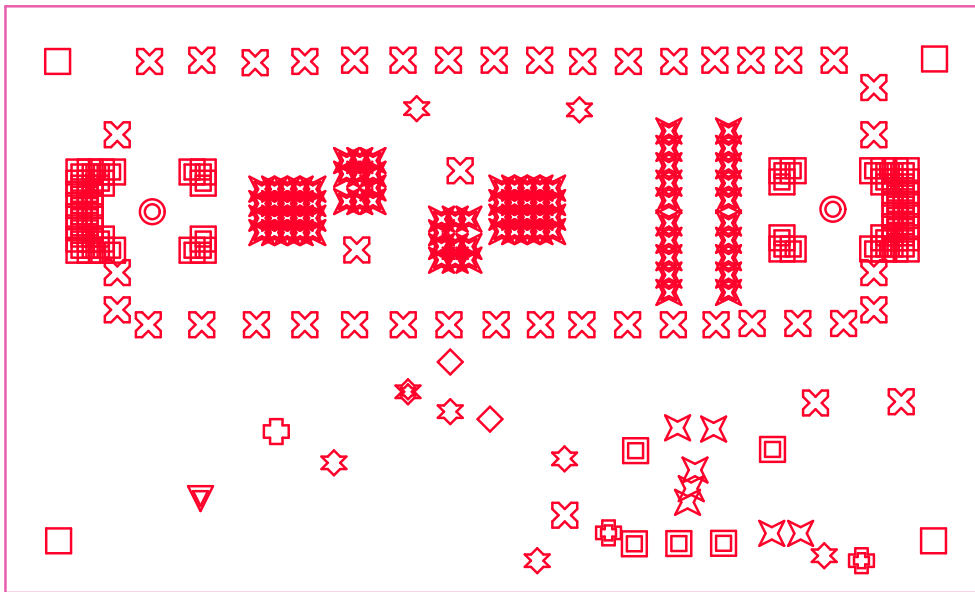
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00795	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00795		
PLOT NAME = Bottom Layer	GENERATED : 2/23/2016 2:37:45 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00795	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00795		
PLOT NAME = Bottom Solder Mask	GENERATED : 2/23/2016 2:37:46 PM	TEXAS INSTRUMENTS	

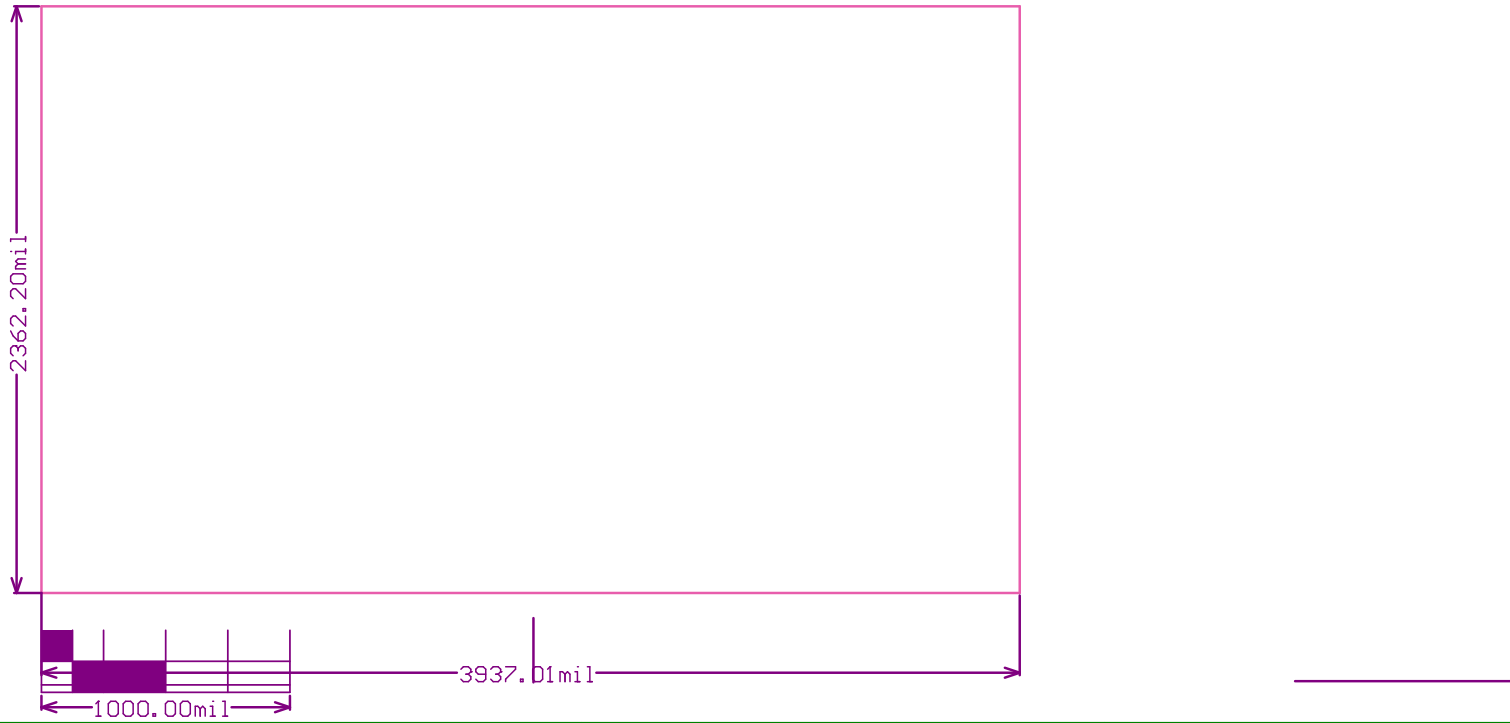


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00795	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00795		
PLOT NAME = Bottom Overlay	GENERATED : 2/23/2016 2:37:47 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
✕	7	11.81mil (0.300mm)	PTH	Round
✕	80	12.00mil (0.305mm)	PTH	Round
✕	44	15.75mil (0.400mm)	PTH	Round
■	61	16.00mil (0.406mm)	PTH	Round
⊕	2	19.69mil (0.500mm)	PTH	Round
⊛	1	27.56mil (0.700mm)	PTH	Round
◇	2	28.00mil (0.711mm)	PTH	Round
⊛	7	40.00mil (1.016mm)	PTH	Round
⊕	1	63.00mil (1.600mm)	PTH	Round
□	4	125.98mil (3.200mm)	PTH	Round
⊙	2	188.00mil (4.775mm)	PTH	Round
▼	1	270.00mil (6.858mm)	PTH	Round
212 Total				

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00795	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00795		
PLOT NAME = Drill Drawing	GENERATED : 2/23/2016	2:37:48 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00795	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00795		
PLOT NAME = Board Dimensions	GENERATED : 2/23/2016	2:37:49 PM	TEXAS INSTRUMENTS



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